

Date: October 16, 2003

NOTICE OF APPEAL FROM THE PRIMARY EXAMINER TO THE BOARD OF APPEALS

In re application of : Paul A. Farrar
App. No. : 09/909,181
For : METHOD OF USING FOAMED
INSULATORS IN THREE
DIMENSIONAL MULTICHIP
STRUCTURES
Filed : July 19, 2001
Examiner : Chris C. Chu
Group Art Unit : 2815

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Mail Stop INTERFERENCE, Board of Patent Appeals and Interferences, U.S. Patent and Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450, on

October 16, 2003

(Date)

Linda H. Liu, Reg. No. 51,240

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Dear Sir:

Applicant hereby appeals to the Board of Patent Appeals and Interferences from the decision dated July 16, 2003 of the Primary Examiner rejecting Claims 1 - 26. The item(s) marked below are appropriate:

- (X) Enclosed is a check in the amount of \$330.00.
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